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3/4/03
Patent Application

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gerald Friese

Examiner: Powell, William A.

Serial No: 09/893,160

Group: Art Unit 1765

Filed: June 27, 2001

Docket: 8055-83CIP (In1292USD1)

For: **POWER PADS FOR APPLICATION OF HIGH CURRENT
PER BOND PAD IN SILICON TECHNOLOGY**

Assistant Commissioner for Patents
Washington, D.C. 20231

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AMENDMENT

This is a response to the Office Action mailed on December 04, 2002. Please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please insert the following paragraph after the Title on page 1 of Applicant's specification:


Cross-Reference to Related Application

B1
This application is a Continuation-in-Part of U.S. Patent Application Serial No. 09/543,691, filed on April 5, 2000.

CERTIFICATE OF MAILING 37 C.F.R. § 1.8(a)

I hereby certify that this correspondence (and any document referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail, postage paid in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on March 4, 2003.

Dated: 3/4/03


Frank V. DeRosa